

PXC-M10xxW Single Output Series: DC-DC Converter Module

9 ~ 36 VDC and 18~ 75 VDC input; 3.3 to 24 VDC Single Output 10 Watts Output Power



FEATURES

- SINGLE OUTPUT UP TO 2.5A
- REINFORCED INSULATION FOR 250VAC WORKING VOLTAGE
- CLEARANCE AND CREEPAGE DISTANCE: 8.0mm/2MOPP
- 5000VAC INPUT TO OUTPUT 2MOPP ISOLATION
- NO MINIMUM LOAD REQUIRED
- HIGH EFFICIENCY UP TO 89%
- BUILT-IN EMI CLASS A FILTER
- 2µA PATIENT LEAKAGE CURRENT
- SMALL SIZE: 1.25×0.80×0.41 INCH
- 4:1 ULTRA WIDE INPUT VOLTAGE RANGE
- FIXED SWITCHING FREQUENCY
- INPUT UNDER-VOLTAGE PROTECTION
- OUTPUT OVER-VOLTAGE PROTECTION
- OVER-CURRENT PROTECTION
- OUTPUT SHORT CIRCUIT PROTECTION
- REMOTE ON/OFF
- COMPLIANT TO RoHS 10 & REACH



CE and UKCA MARKED SAFETY APPROVALS:

ANSI/AAMI ES60601-1

EN60601-1 IEC60601-1

APPLICATIONS

- MEDICAL EQUIPMENT
- TELECOM/DATACOM
- INDUSTRY CONTROL SYSTEM
- MEASUREMENT EQUIPMENT
- SEMICONDUCTOR EQUIPMENT
- PV POWER SYSTEM
- IGBT GATE DRIVER

OPTIONS

- PIN CONNECTION
- REMOTE ON/OFF
- TRIM

GENERAL DESCRIPTIONS

The PXC-M10W series offer 10 watts of output power from a 1.25 x 0.80 x 0.41 inch package. PXC-M10W series have 4:1 wide input voltage of 9~36VDC and 18~75VDC. The PXC-M10W has features 5000VAC of isolation, short circuit protection, over-current protection and over-voltage protection. All models are particularly suited to IGBT isolated power supplies, measurement equipment, telecommunications, industrial and medical equipment applications.





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Outpo	ut Specifications	S			
Parameter	Model	Min	Тур	Max	Unit
Output Voltage	xxWS3P3	3.267	3.3	3.333	
(Vin(nom); Full Load; Ta=25°C)	xxW S05	4.95	5	5.05	
	xxWS12	11.88	12	12.12	VDC
	xxW S15	14.85	15	15.15	
	xxW S24	23.76	24	24.24	
Output Regulation					
Line (Vin(min) to Vin(max); Full Load)	All	-0.2		+0.2	%
Load (0% to 100% of Full Load)		-0.2		+0.2	
Output Ripple and Noise					
Peak to Peak (20MHz Bandwidth)					
With a 10μF/25V X7R MLCC	xxWS3P3		30	75	
•	xxW S05		30	75	
	xxW S12		40	100	mVp-p
	xxWS15		40	100	
With a 4.7µF/50V X7R MLCC	xxW S24		50	100	
Voltage adjustability (see page 26)	xxW S 3P3- T	-10		+10	
(Only for B-type Pin connection option)	xxW S 05- T	-10		+10	
(Only for B type I in connection opacin)	xxW S 12- T	-10		+10	% of Vout
	xxW S 15- T	-10		+20	70 OI VOUL
	xxW S24-T	-10		+20	
Temperature Coefficient	All	-0.02		+0.02	%/°C
Output Voltage Overshoot		0.02			
(Vin,min to Vin,max; Full Load; Ta=25°C)	All		0	3	% of Vout
Dynamic Load Response					
(Vin= Vin(nom); Ta=25°C)					
Load step change from					
75% to 100% or 100 to 75% of Full Load					
Peak Deviation	All		3		% of Vout
Setting Time (Vo < 10% peak deviation)	All		250		μs
Output Current	xxWS3P3	0		2500	
	xxW S05	0		2000	
	xxWS12	0		830	mA
	xxWS15	0		670	
	xxW S24	0		416	
Output Capacitance Load	xxWS3P3			3000	
	xxW S05			2500	
	xxWS12			430	μF
	xxW S 15			350	F.
	xxWS24			125	
Output Over Voltage Protection (see page 28)	xxWS3P3	3.7		5	
	xxWS05	5.6		7.0	
	xxWS12	13.5		16	VDC
	xxWS15	18.3		22.0	1 ,50
	xxWS24	29.1		34.5	
Output Over Current Protection (see page 28)		20.1		54.5	1
(% of lout rated; Hiccup mode)	All		150		% of FL
Output Short Circuit Protection (see page 28)	All	(Continuous, aut	tomatic recove	i.
Taipat Short On out 1 Totobion (300 page 20)	, vii		Jornaldous, au	Ciliatio 1000VC	



Inpu	t Specifications				
Parameter	Model	Min	Тур	Max	Unit
Operating Input Voltage					
Continuous	24WSxx	9	24	36	
	48WSxx	18	48	75	VDC
Transient (3sec,max)	24WSxx			50	
	48WSxx			100	
Input Standby Current	24WS3P3		6		
(Typ. value at Vin(nom); No Load)	24WS05		6		
	24WS12		6		
	24WS15		6		
	24WS24		6		1
	48WS3P3		4		mA
	48WS05		4		
	48WS12		4		
	48WS15		4		
	48WS24		4		
Under Voltage Lockout Turn-on Threshold	24WSxx			9	\/DC
-	48WSxx			18	VDC
Under Voltage Lockout Turn-off Threshold	24WSxx		8		VDC
	48WSxx		16		VDC
Input reflected ripple current	All		20		mAp-p
(5 to 20MHz, 12µH source impedance)	All		20		підр-р
Start Up Time					
(Vin(nom) and constant resistive load)	All				ms
Power up	All		30		1115
Remote ON/OFF			30		
Remote ON/OFF Control Type B (see page 29)					
(The Ctrl pin voltage is referenced to negative input)	xxW S xx- P				
Ctrl pin Low Voltage, Module ON	AA W OAA- <u>F</u>		Short or 0		
Ctrl pin High Voltage, Module OFF			Open or 2.2	2 ~ 12VDC	
Input Current of Remote Control Pin		-0.5		1	mA
Remote Off State Input Current			2.5		mA



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Gene	eral Specification	S			
Parameter	Model	Min	Тур	Max	Unit
Efficiency	24WS3P3		83		
(Vin(nom); Full Load; Ta=25°C)	24WS05		86.5		
	24WS12		89		
	24WS15		89		
	24WS24		89		%
	48WS3P3		82.5		76
	48WS05		86.5		
	48WS12		89		
	48WS15		89		
	48WS24		88.5		
Isolation voltage (1 minute)	All				VAC
Input to Output	All	5000			VAO
Isolation capacitance	All		12	17	pF
Leakage current (240VAC,60Hz)	All			2	μΑ
Switching Frequency	All	270	300	330	kHz
Clearance/Creepage	All	8			mm
Weight	All		14.0		g
MTBF(see page 33)	All				houre
MIL-HDBK-217F Ta=25°C, Full load	All		3.849 x 10 ⁶		hours
Safety Approvals	All		ANSI/AAMI	ES60601-1	
	All		IEC60601-1	, EN60601-1	
Case Material			Non-conductiv	e black plastic	
Base Material	All		Non-conductiv	e black plastic	
Potting Material	All		Silicone (UL94 V-0)	

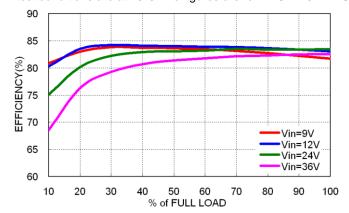
Environmental Specifications									
Parameter	Model	Min	Тур	Max	Unit				
Operating Ambient Temperature									
Without Derating	All	-40		77	°C				
With Derating		77		105					
Storage Temperature	All	-55		125	°C				
Thermal Impedance (20LFM)	All		18		°C/W				
Relative humidity	All	5 95 9							
Thermal Shock	All	MIL-STD-810F							
Vibration	All		MIL-STI	D-810F					

EMC	C Characteristics				
Characteristic	Standard	Cond	lition	Level	
EMI	EN55011				
	EN55032	Module sta	and-alone	Class A	
	FCC Part 18				
	EN55011				
	EN55032	With externa	Class B		
	FCC Part 18				
ESD	EN61000-4-2	Air	±8kV	Perf. Criteria A	
E3D	EN01000-4-2	Contact	±6kV	Fell. Cillella A	
Radiated Immunity	EN61000-4-3		10V/m	Perf. Criteria A	
Fast Transient(see page 30)	EN61000-4-4		±2kV	Perf. Criteria A	
Surge(see page 30)	EN61000-4-5	•	±2kV	Perf. Criteria A	
Conducted Immunity	EN61000-4-6	_	10V r.m.s	Perf. Criteria A	

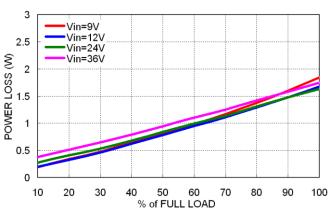


Characteristic Curves

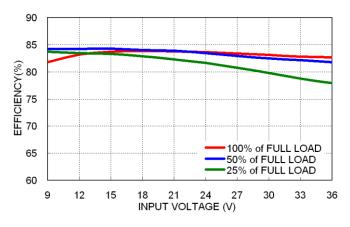
All test conditions are at 25°C. The figures are for PXC-M10-24WS3P3



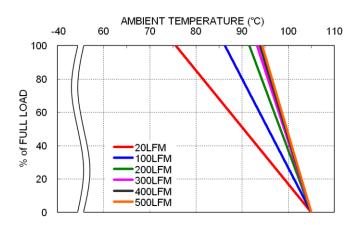
Efficiency versus Output Current



Power Dissipation versus Output Current



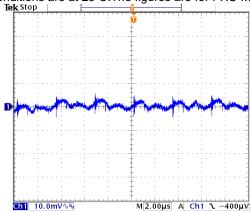
Efficiency versus Input Voltage Full Load



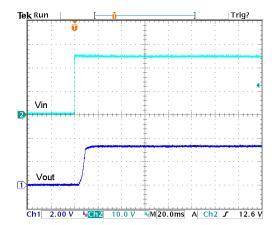
Derating Output Current versus Ambient Temperature and Airflow Vin(nom)



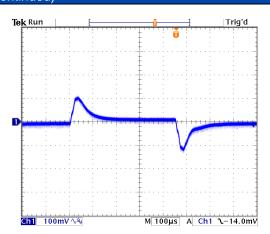
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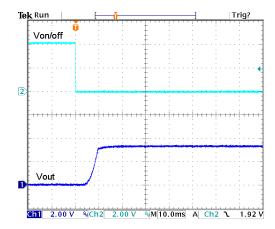
Typical Output Ripple and Noise. Vin(nom); Full Load



Typical Input Start-Up and Output Rise Characteristic Vin(nom); Full Load



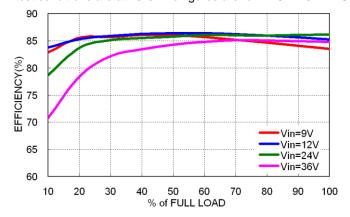
Transient Response to Dynamic Load Change from 100% to 75% to 100% of Full Load; Vin(nom)



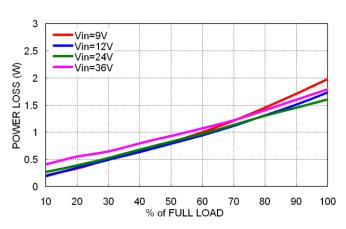
Using ON/OFF Voltage Start-Up and Output Rise Characteristic Vin(nom); Full Load



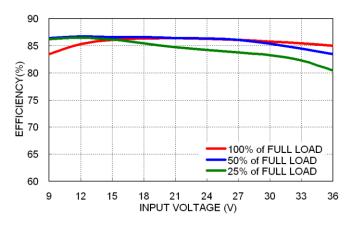
All test conditions are at 25°C. The figures are for PXC-M10-24WS05



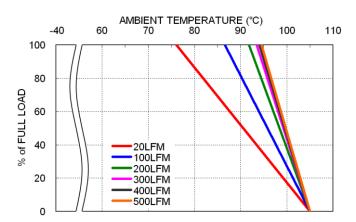
Efficiency versus Output Current



Power Dissipation versus Output Current



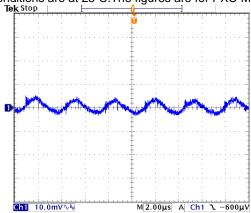
Efficiency versus Input Voltage Full Load



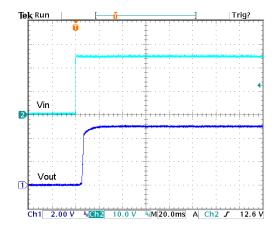
Derating Output Current versus Ambient Temperature and Airflow Vin(nom)



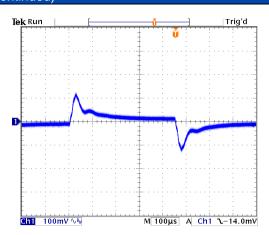
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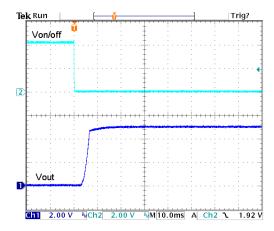
Typical Output Ripple and Noise. Vin(nom); Full Load



Typical Input Start-Up and Output Rise Characteristic Vin(nom); Full Load



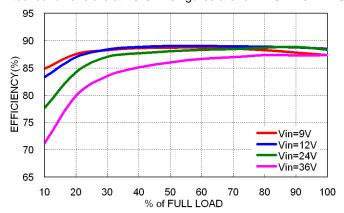
Transient Response to Dynamic Load Change from 100% to 75% to 100% of Full Load; Vin(nom)



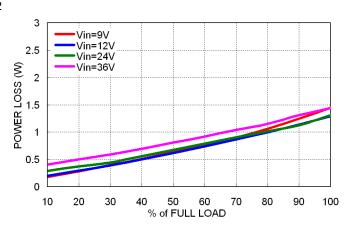
Using ON/OFF Voltage Start-Up and Output Rise Characteristic Vin(nom); Full Load



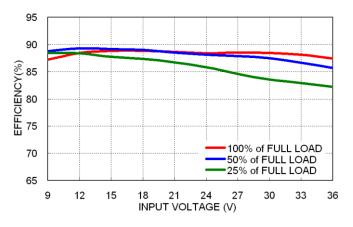
All test conditions are at 25°C. The figures are for PXC-M10-24WS12



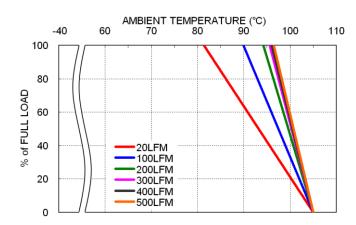
Efficiency versus Output Current



Power Dissipation versus Output Current



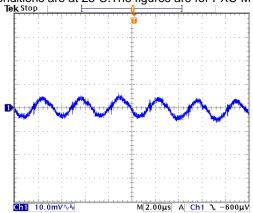
Efficiency versus Input Voltage Full Load



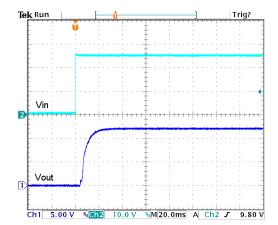
Derating Output Current versus Ambient Temperature and Airflow Vin(nom)



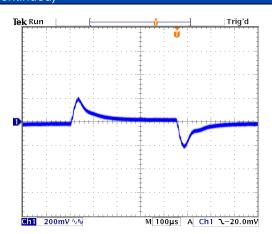
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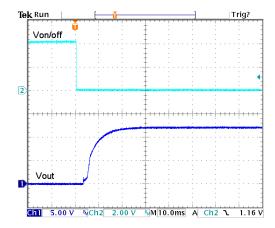
Typical Output Ripple and Noise. Vin(nom); Full Load



Typical Input Start-Up and Output Rise Characteristic Vin(nom); Full Load



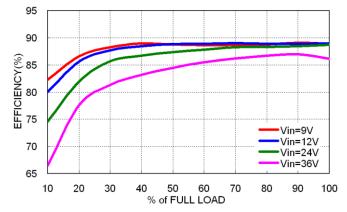
Transient Response to Dynamic Load Change from 100% to 75% to 100% of Full Load; Vin(nom)



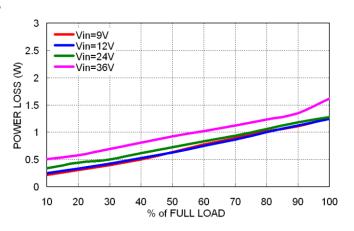
Using ON/OFF Voltage Start-Up and Output Rise Characteristic Vin(nom); Full Load



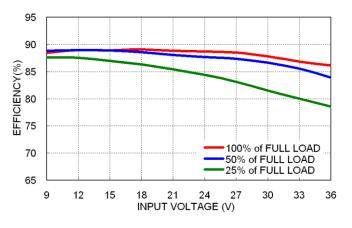
All test conditions are at 25°C. The figures are for PXC-M10-24WS15



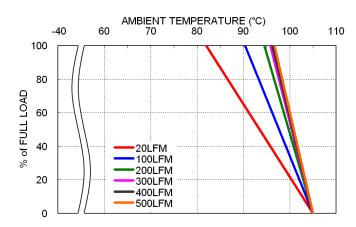
Efficiency versus Output Current



Power Dissipation versus Output Current



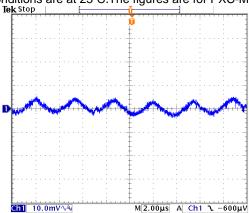
Efficiency versus Input Voltage Full Load



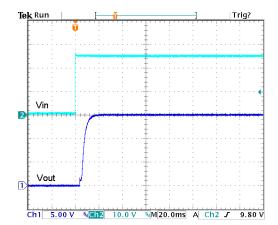
Derating Output Current versus Ambient Temperature and Airflow Vin(nom)



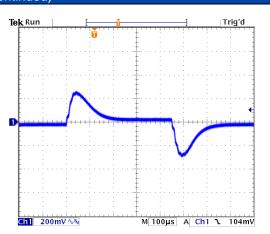
All test conditions are at 25°C. The figures are for PXC-M10-24WS15



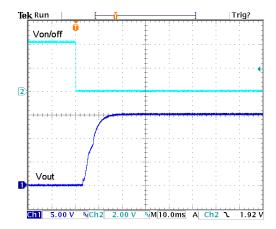
Typical Output Ripple and Noise. Vin(nom); Full Load



Typical Input Start-Up and Output Rise Characteristic Vin(nom); Full Load

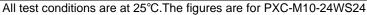


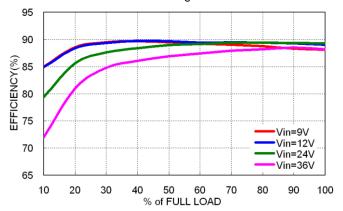
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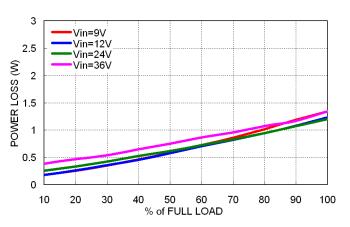
Using ON/OFF Voltage Start-Up and Output Rise Characteristic Vin(nom); Full Load



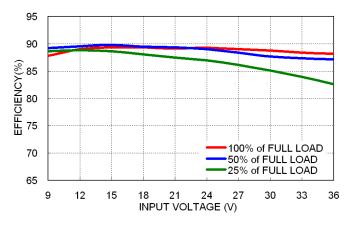




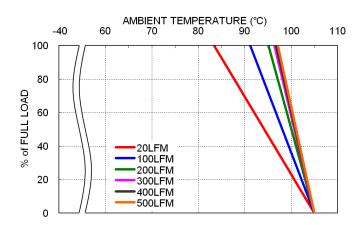
Efficiency versus Output Current



Power Dissipation versus Output Current



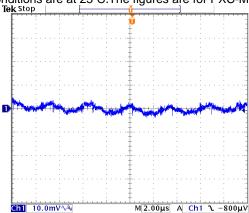
Efficiency versus Input Voltage Full Load



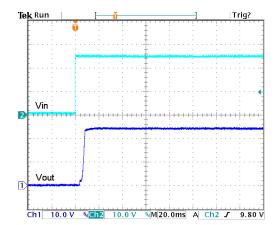
Derating Output Current versus Ambient Temperature and Airflow Vin(nom)



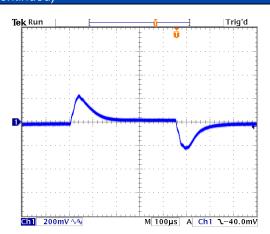
All test conditions are at 25°C.The figures are for PXC-M10-24WS24



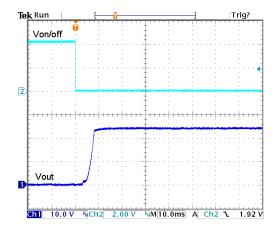
Typical Output Ripple and Noise. Vin(nom); Full Load



Typical Input Start-Up and Output Rise Characteristic Vin(nom); Full Load



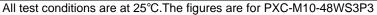
Transient Response to Dynamic Load Change from 100% to 75% to 100% of Full Load; Vin(nom)

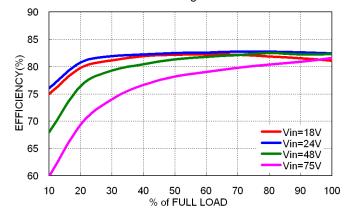


Using ON/OFF Voltage Start-Up and Output Rise Characteristic Vin(nom); Full Load

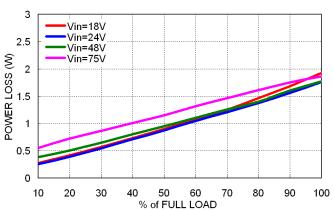


Characteristic Curves

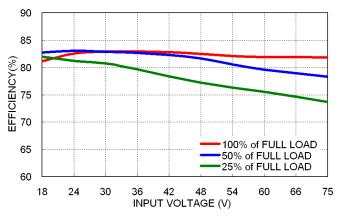




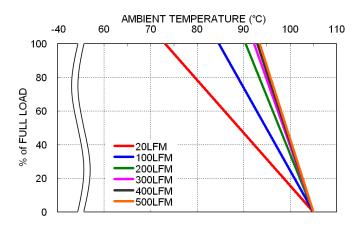
Efficiency versus Output Current



Power Dissipation versus Output Current



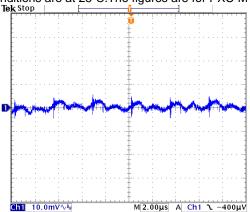
Efficiency versus Input Voltage Full Load



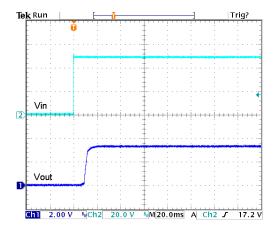
Derating Output Current versus Ambient Temperature and Airflow Vin(nom)



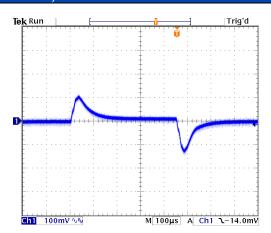
All test conditions are at 25°C. The figures are for PXC-M10-48WS3P3



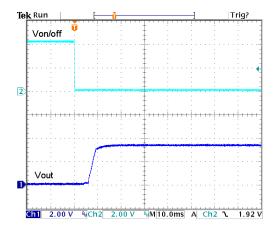
Typical Output Ripple and Noise. Vin(nom); Full Load



Typical Input Start-Up and Output Rise Characteristic Vin(nom); Full Load

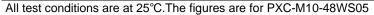


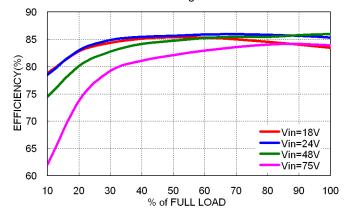
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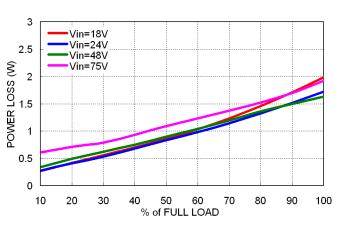
Using ON/OFF Voltage Start-Up and Output Rise Characteristic Vin(nom); Full Load



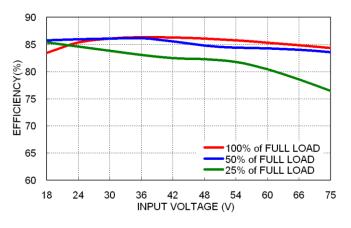




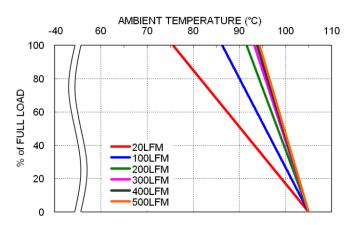
Efficiency versus Output Current



Power Dissipation versus Output Current



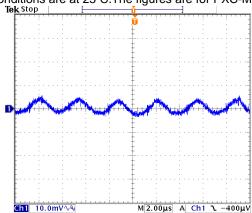
Efficiency versus Input Voltage Full Load



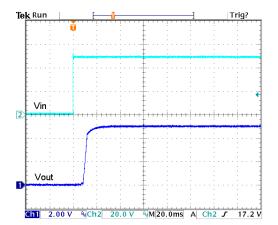
Derating Output Current versus Ambient Temperature and Airflow Vin(nom)



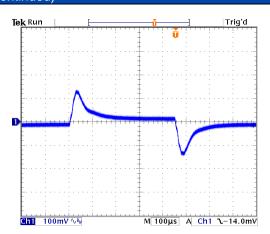
All test conditions are at 25°C. The figures are for PXC-M10-48WS05



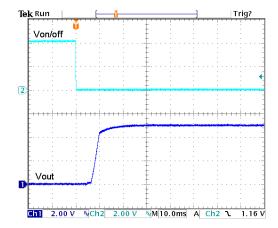
Typical Output Ripple and Noise. Vin(nom); Full Load



Typical Input Start-Up and Output Rise Characteristic Vin(nom); Full Load



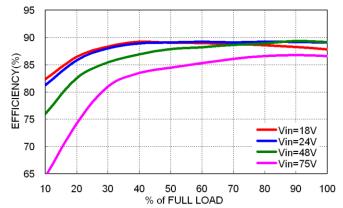
Transient Response to Dynamic Load Change from 100% to 75% to 100% of Full Load; Vin(nom)



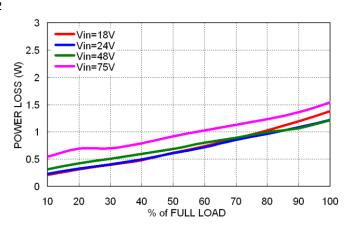
Using ON/OFF Voltage Start-Up and Output Rise Characteristic Vin(nom); Full Load



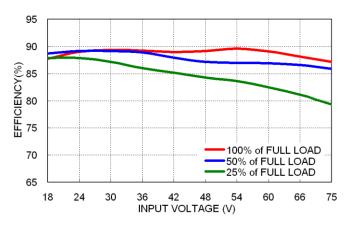
All test conditions are at 25°C. The figures are for PXC-M10-48WS12



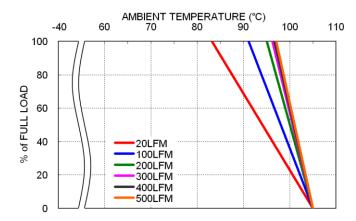
Efficiency versus Output Current



Power Dissipation versus Output Current



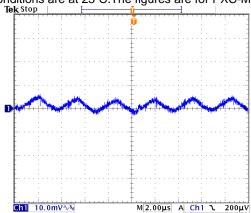
Efficiency versus Input Voltage Full Load



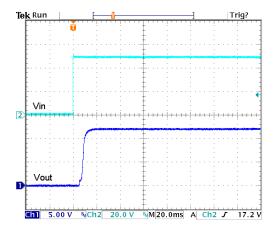
Derating Output Current versus Ambient Temperature and Airflow Vin(nom)



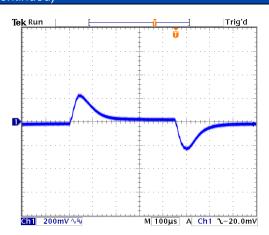
All test conditions are at 25°C. The figures are for PXC-M10-48WS12



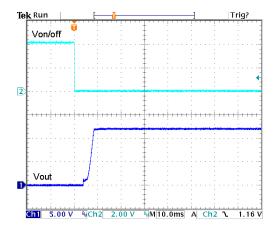
Typical Output Ripple and Noise. Vin(nom); Full Load



Typical Input Start-Up and Output Rise Characteristic Vin(nom); Full Load

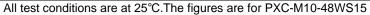


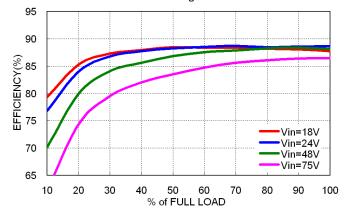
Transient Response to Dynamic Load Change from 100% to 75% to 100% of Full Load; Vin(nom)



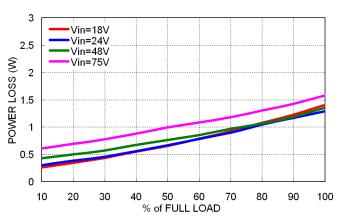
Using ON/OFF Voltage Start-Up and Output Rise Characteristic Vin(nom); Full Load



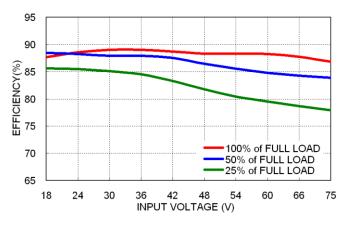




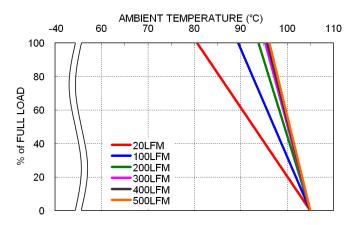
Efficiency versus Output Current



Power Dissipation versus Output Current



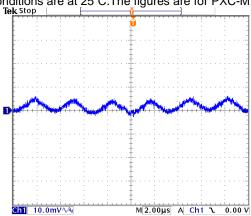
Efficiency versus Input Voltage Full Load



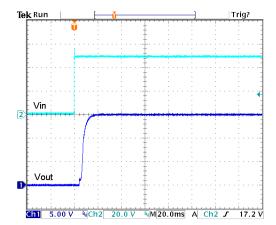
Derating Output Current versus Ambient Temperature and Airflow Vin(nom)



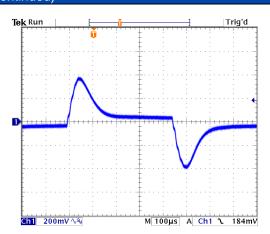
All test conditions are at 25°C.The figures are for PXC-M10-48WS15



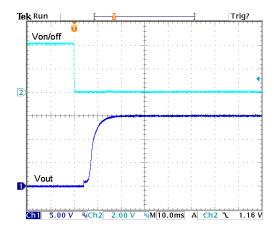
Typical Output Ripple and Noise. Vin(nom); Full Load



Typical Input Start-Up and Output Rise Characteristic Vin(nom); Full Load



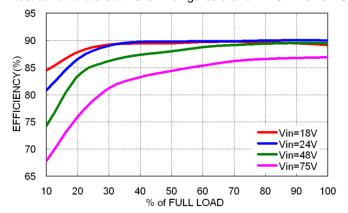
Transient Response to Dynamic Load Change from 100% to 75% to 100% of Full Load; Vin(nom)



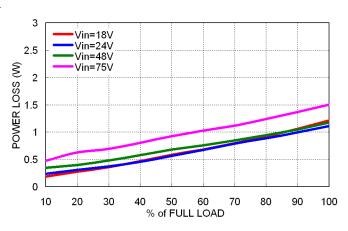
Using ON/OFF Voltage Start-Up and Output Rise Characteristic Vin(nom); Full Load



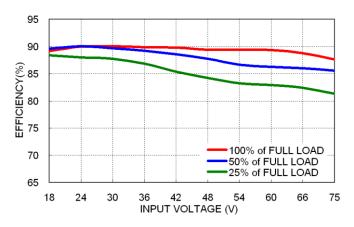
All test conditions are at 25°C. The figures are for PXC-M10-48WS24



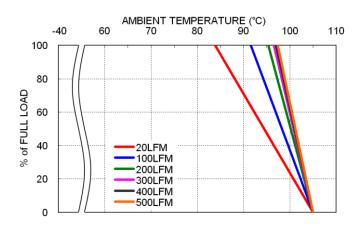
Efficiency versus Output Current



Power Dissipation versus Output Current



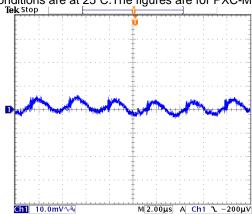
Efficiency versus Input Voltage Full Load



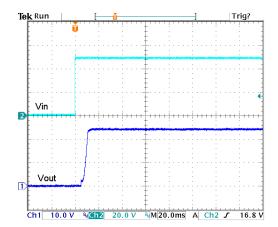
Derating Output Current versus Ambient Temperature and Airflow Vin(nom)



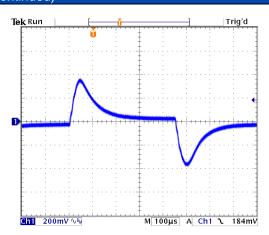
All test conditions are at 25°C.The figures are for PXC-M10-48WS24



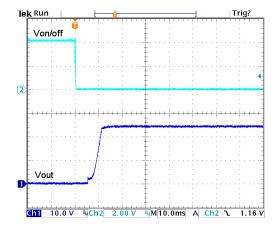
Typical Output Ripple and Noise. Vin(nom); Full Load



Typical Input Start-Up and Output Rise Characteristic Vin(nom); Full Load



Transient Response to Dynamic Load Change from 100% to 75% to 100% of Full Load; Vin(nom)



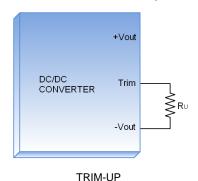
Using ON/OFF Voltage Start-Up and Output Rise Characteristic Vin(nom); Full Load

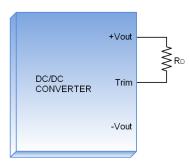


Output Voltage Adjustment

Output voltage adjustment is an optional function for PXC-M10-xxWSxx-xT.

It allows the user to increase or decrease the output voltage of the module. This is accomplished by connecting an external resistor between the TRIM pin and either the +Vout or -Vout pins. With an external resistor between the TRIM and -OUTPUT pin, the output voltage increases. With an external resistor between the TRIM and +OUTPUT pin, the output voltage decreases. The external TRIM resistor needs to be at least 1/16W of rated power.





TRIM-DOWN

Output voltage adjustment configurations

TRIM TABLE

RD

 $(k\Omega)$

xxWS3P	3-xT	TRIN	1-UP								
Trim-Up	(%)	1	2	3	4	5	6	7	8	9	10
Vout	(V)	3.333	3.366	3.399	3.432	3.465	3.498	3.531	3.564	3.597	3.630
RU	$(k\Omega)$	385.837	191.894	127.246	94.922	75.527	62.598	53.362	46.436	41.049	36.739
		TRIM-I	DOWN								
Trim-Down	(%)	1	2	3	4	5	6	7	8	9	10
Vout	(V)	3.267	3.234	3.201	3.168	3.135	3.102	3.069	3.036	3.003	2.970
RD	$(k\Omega)$	114.963	53.906	33.554	23.378	17.273	13.202	10.295	8.114	6.418	5.061
xxW S 05	5-xT	TRIN	1-UP								
Trim-Up	(%)	1	2	3	4	5	6	7	8	9	10
Vout	(V)	5.048	5.098	5.148	5.198	5.248	5.298	5.348	5.398	5.448	5.498
RU	(kΩ)	252.301	125.126	82.734	61.538	48.820	40.342	34.286	29.744	26.211	23.385
		TRIM-I	DOWN								
Trim-Down	(%)	1	2	3	4	5	6	7	8	9	10
Vout	(V)	4.948	4.898	4.848	4.798	4.748	4.698	4.648	4.598	4.548	4.498
RD	$(k\Omega)$	248.499	120.674	78.066	56.762	43.980	35.458	29.371	24.806	21.255	18.415
xxWS12	2-xT	TRIN	1-UP								
Trim-Up	(%)	1	2	3	4	5	6	7	8	9	10
Vout	(V)	12.121	12.241	12.361	12.481	12.601	12.721	12.841	12.961	13.081	13.201
RU	(kΩ)	202.645	98.772	64.148	46.836	36.449	29.524	24.578	20.868	17.983	15.674
		TRIM-I	DOWN								
Trim-Down	(%)	1	2	3	4	5	6	7	8	9	10
Vout	(V)	11.881	11.761	11.641	11.521	11.401	11.281	11.161	11.041	10.921	10.801

777.155

381.028

248.985

182.964

143.351

116.943

98.079

83.932

72.928

64.126



Output Voltage Adjustment (Continued)

TRIM TABLE (Continued)

xxWS18	5-xT	TRIM	1-UP								
Trim-Up	(%)	2	4	6	8	10	12	14	16	18	20
Vout	(V)	15.305	15.605	15.905	16.205	16.505	16.806	17.106	17.406	17.706	18.006
RU	(kΩ)	77.962	36.431	22.587	15.665	11.512	8.744	6.766	5.283	4.129	3.206

TRIM-DOWN

	Trim-Down	(%)	1	2	3	4	5	6	7	8	9	10
	Vout	(V)	14.855	14.705	14.555	14.405	14.255	14.105	13.955	13.805	13.654	13.504
Γ	RD	(kΩ)	818.776	401.838	262.859	193.369	151.675	123.879	104.025	89.135	77.553	68.288

xxW S2 4	4-xT	TRIN	/I-UP								
Trim-Up	(%)	2	4	6	8	10	12	14	16	18	20
Vout	(V)	24.484	24.964	25.444	25.924	26.404	26.884	27.364	27.844	28.324	28.804
RU	(kΩ)	277.598	132.299	83.866	59.650	45.120	35.433	28.514	23.325	19.289	16.060

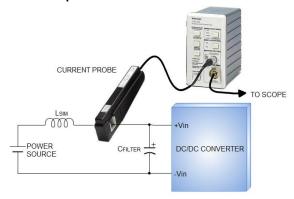
TRIM-DOWN

Trim-Down	(%)	1	2	3	4	5	6	7	8	9	10
Vout	(V)	23.764	23.524	23.283	23.043	22.803	22.563	22.323	22.083	21.843	21.603
RD	(kΩ)	4949.803	2440.402	1603.934	1185.701	934.761	767.467	647.972	558.350	488.645	432.880

Input Source Impedance

The power module should be connected to a low impedance input source. Highly inductive source impedance can affect the stability of the power module. Install choke (LSIM) to simulate the impedance of power source. External input capacitors CFILTER serve primarily as energy-storage elements, minimizing line voltage variations caused by transient IR drops in conductors from backplane to the DC/DC. The capacitor must as close as possible to the input terminals of the power module for lower impedance. The input reflected-ripple current measurement configuration is shown below:

Input reflected-ripple current measurement setup



PXC-M10-24WSxx

Component	Value	Voltage	Reference
Lsim	12µH		Inductor
CFILTER	47µF	100V	Nippon chemi-con KY-series

PXC-M10-48WSxx

1 AO III 10 - FOR CAA					
Component	Value	Voltage	Reference		
Lsim	12µH		Inductor		
CELLER	47uF	100V	Nippon chemi-con KY-series		



Output Over Current Protection

When excessive output currents occur in the system, circuit protection is required on all power supplies. Normally, overload current is maintained at approximately 150 percent of rated current for PXC-M10W SERIES.

Hiccup-mode is a method of operation in a power supply whose purpose is to protect the power supply from being damaged during an over-current fault condition. It also enables the power supply to restart when the fault is removed. There are other ways of protecting the power supply when it is over-loaded, such as the maximum current limiting or current fold-back methods.

One of the problems resulting from over current is that excessive heat may be generated in power devices; especially MOSFET and Schottky diodes and the temperature of those devices may exceed their specified limits. A protection mechanism has to be used to prevent those power devices from being damaged.

The operation of hiccup is as follows. When the current sense circuit sees an over-current event, the controller shuts off the power supply for a given time and then tries to start up the power supply again. If the over-load condition has been removed, the power supply will start up and operate normally; otherwise, the controller will see another over-current event and shut off the power supply again, repeating the previous cycle. Hiccup operation has none of the drawbacks of the other two protection methods, although its circuit is more complicated because it requires a timing circuit. The excess heat due to overload lasts for only a short duration in the hiccup cycle, hence the junction temperature of the power devices is much lower.

The hiccup operation can be done in various ways. For example, one can start hiccup operation any time an over-current event is detected; or prohibit hiccup during a designated start-up is usually larger than during normal operation and it is easier for an over-current event is detected; or prohibit hiccup during a designated start-up interval (usually a few milliseconds). The reason for the latter operation is that during start-up, the power supply needs to provide extra current to charge up the output capacitor. Thus the current demand during start-up is usually larger than during normal operation and it is easier for an over-current event to occur. If the power supply starts to hiccup once there is an over-current, it might never start up successfully. Hiccup mode protection will give the best protection for a power supply against over current situations, since it will limit the average current to the load at a low level, so reducing power dissipation and case temperature in the power devices.

Output Short Circuitry Protection

Continuous and auto-recovery mode.

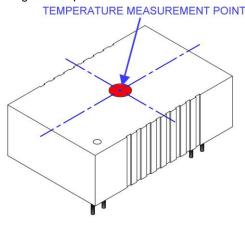
During short circuit, converter still shut down. The average current during this condition will be very low and the device can be safety in this condition.

Output Over Voltage Protection

The output over-voltage protection consists of circuitry that internally clamps the output voltage. If a more accurate output over-voltage protection scheme is required then this should be implemented externally via use of the remote on/off pin.

Thermal Considerations

The power module operates in a variety of thermal environments; however, sufficient cooling should be provided to help ensure reliable operation of the unit. Heat is removed by conduction, convection, and radiation to the surrounding environment. Proper cooling can be verified by measuring the point as shown in the figure below. The temperature at this location should not exceed 105°C. When operating, adequate cooling must be provided to maintain the test point temperature at or below 105°C. Although the maximum point temperature of the power modules is 105°C, limiting this temperature to a lower value enhances the reliability.



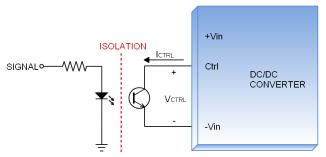


Remote On/Off Control

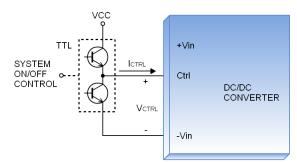
Only for B-type pin connection option with suffix -P,. Ex.: PXC-M10-24WS05-P

The module is ON during logic Low and turns OFF during logic High. The Ctrl pin is an open collector/drain logic input signal that is referenced to (-)Vin. If not using the remote on/off feature, the Ctrl and (-)Vin pins should be connected together (shorted) or apply 0-1.2V between these two pins for the module to be ON.

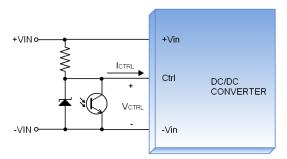
Remote ON/OFF Implementation



Isolated-Control Remote ON/OFF



Level Control Using TTL Output

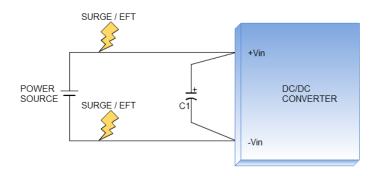


Level Control Using Line Voltage



EMS Considerations

The PXC-M10W series can meet Fast Transient EN61000-4-4 and Surge EN61000-4-5 performance criteria A with external components connected to the input terminals of the module. Please see the following schematic:



SURGE / Fast Transient

PXC-M10-24WSxx

Component	Value	Voltage	Reference	
C1	470µF	50V	Nippon chemi-con KY-series	

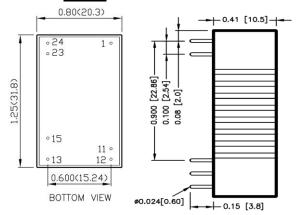
PXC-M10-48WSxx

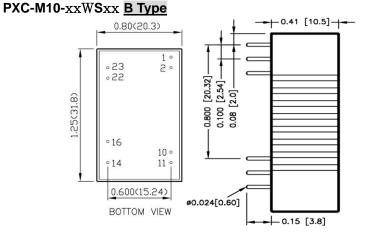
Component	Value	Voltage	Reference
C1	330µF	100V	Nippon chemi-con KY-series



Mechanical Data

PXC-M10-xxWSxx A Type





PIN CONNECTION

PIN	FUNCTION			
1	+ Vin			
11	No pin			
12	-Vout			
13	+Vout			
15	No pin			
23	- Vin			
24	- Vin			

1. All dimensions in Inch (mm)

2. Tolerance: X.XX±0.02 (X.X±0.5) X.XXX±0.01 (X.XX±0.25)

3. Pin pitch tolerance ±0.01 (0.25)

4. Pin dimension tolerance ±0.004 (0.1)

PIN CONNECTION

PIN	FUNCTION			
1	Ctrl (Option) / No pin*			
2	- Vin			
10	Trim (Option) / No pin*			
11	No pin / NC**			
14	+Vout			
16	-Vout			
22	+Vin			
23	+Vin			

* If no Ctrl or Trim option, there is no pin on the corresponding pin number.

** Pin 11 is "No pin" for

 $\begin{array}{l} \mathsf{PXC\text{-}M10\text{-}xx}\mathsf{Sxx}\mathsf{W}\underline{\mathbf{B}\text{-}}\underline{\mathbf{T}} \\ \mathsf{PXC\text{-}M10\text{-}xx}\mathsf{Sxx}\mathsf{W}\underline{\mathbf{B}\text{-}P}\underline{\mathbf{T}} \end{array}$

Pin 11 is "NC" for

PXC-M10-xxSxxW<u>B</u>

 $\mathsf{PXC}\text{-}\mathsf{M10}\text{-}\mathsf{xx}\mathsf{Sxx}\mathsf{W}\underline{\textbf{\textbf{B}}}\text{-}\mathsf{P}$

1. All dimensions in Inch (mm)

2. Tolerance: X.XX±0.02 (X.X±0.5) X.XXX±0.01 (X.XX±0.25)

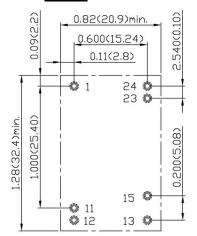
3. Pin pitch tolerance ±0.01 (0.25)

4. Pin dimension tolerance ±0.004 (0.1)

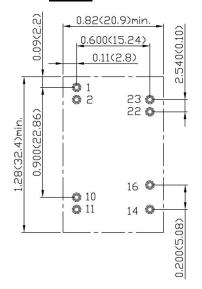


Recommended Pad Layout

PXC-M10-xxWSxx A Type



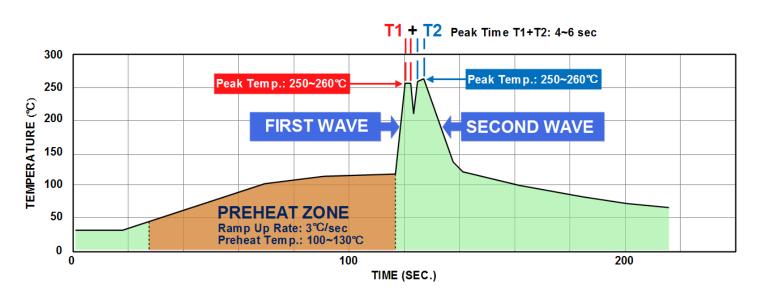
PXC-M10-xxWSxx B Type



- . All dimensions in Inch (mm)
 Tolerance: X.XX±0.02 (X.X±0.5)
 X.XXX±0.01 (X.XX±0.25)
- 2. Pin pitch tolerance ±0.01 (0.25)
- 3. Pin dimension tolerance ±0.004 (0.1)

Soldering Considerations

Lead free wave solder profile

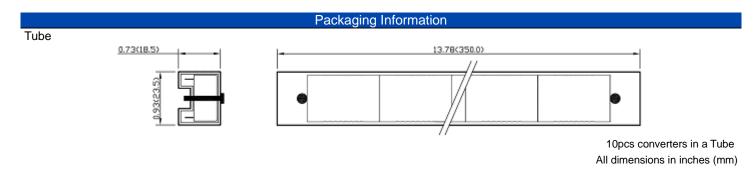


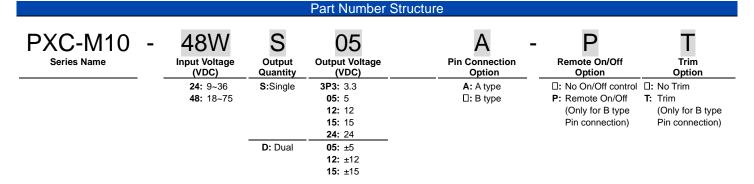
 $Reference\ Solder:\ Sn-Ag-Cu\ ;\ Sn-Cu$

Hand Soldering (Reference):
Soldering iron: Power 150W
Soldering Time: 3~6 sec
Temp: 410~430°C

32 Application Note **www.us.lambda.tdk.com**







Model Number	Input Range	Output Voltage	Output Current @Full Load	Input Current @ No Load	Efficiency	Maximum Capacitor Load
	VDC	VDC	mA	mA	%	μF
PXC-M10-24WS3P3A/□	9 ~ 36	3.3	2500	6	83	3000
PXC-M10-24WS05A/□		5	2000	6	86.5	2500
PXC-M10-24WS12A/□		12	830	6	89	430
PXC-M10-24WS15A/□		15	670	6	89	350
PXC-M10-24WS24A/□		24	416	6	89	125
PXC-M10-48WS3P3A/□	18 ~ 75	3.3	2500	4	82.5	3000
PXC-M10-48WS05A/□		5	2000	4	86.5	2500
PXC-M10-48WS12A/□		12	830	4	89	430
PXC-M10-48WS15A/□		15	670	4	89	350
PXC-M10-48WS24A/□		24	416	4	88.5	125

Safety and Installation Instructions

Fusing Consideration

Caution: This power module is not internally fused. An input line fuse must always be used.

This encapsulated power module can be used in a wide variety of applications, ranging from simple stand-alone operation to an integrated part of sophisticated power architecture. For maximum flexibility, internal fusing is not included; however, to achieve maximum safety and system protection, always use an input line fuse. See suggested values below:

Model	Fuse Rating (A)	Fuse Type
PXC-M10-24WSxx	2	Slow-Blow
PXC-M10-48WSxx	1	Slow-Blow

Based on the information provided in this data sheet on inrush energy and maximum dc input current at low Vin.

MTBF and Reliability

The MTBF has been calculated using:

MIL-HDBK 217F NOTICE2 FULL LOAD, Operating Temperature at 25°C. The resulting figure for MTBF is 3.849×10⁶ hours.